

# **Powerline N-Channel IGBT With Ultrafast Diode**

Advance Information

DS5072 - 1.1 January 1999

The ITZ25C12 is a very robust non punch through nchannel, enhancement mode insulated gate bipolar transistor (IGBT) designed for low power dissipation in a wide range of high voltage applications such as power supplies and motor drives. The high impedance gate simplifies gate drive considerations, allowing operation directly from low power control circuitry.

Fast rise and fall times allow very high frequency switching making the device suitable for modern systems employing high frequency switching.

Low saturation voltages minimise power dissipation, thereby reducing the cost of the overall system in which they are used.

The ITZ is fully short circuit rated making it especially suited for motor control and other applications requiring short circuit with stand capability. Each device in the Powerline range is available with or without an integral anti-parallel ultrafast soft recovery diode, see separate datasheet for discrete device

Typical applications include high frequency inverters for motor control, welding and heating apparatus. The Powerline range of IGBTs is also applicable to switched mode and uninterruptible power supplies.

#### **FEATURES**

- Enhancement Mode n-Channel Device
- Non Punch Through Structure
- High Switching Speed
- Low On-state Saturation Voltage
- High Input Impedance Simplifies Gate Drive
- Latch-Free Operation
- Fully Short Circuit Rated To 10µs
- Square RBSOA
- Integral Fast Recovery Diode

### **APPLICATIONS**

- High Frequency Inverters
- Motor Control
- Switched Mode Power Supplies
- High Frequency Welding
- Heating/Cooking Apparatus

#### **KEY PARAMETERS**

V <sub>CES</sub>	(max)	1200V
V CES V CE(sat)	(typ)	2.8V
I <sub>C25</sub>	(max)	40A
I <sub>C85</sub>	(max)	25A
I <sub>CM</sub>	(max)	75A
t	(max)	<b>10</b> μ <b>s</b>

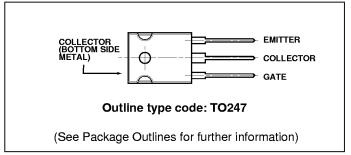


Fig.1 Pin connections - top view (not to scale)

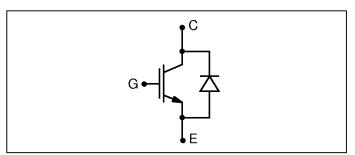


Fig.2 ITZ25C12 circuit

#### **ORDERING INFORMATION**

ITZ25C12P TO247 (with fast recovery diode)

Note: When ordering, use the complete part number.

Caution: These devices are sensitive to electrostatic discharge. Users should observe proper ESD handling precautions.

### ITZ25C12

## **ABSOLUTE MAXIMUM RATINGS**

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device.

T<sub>case</sub> = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Max.	Units
V <sub>CES</sub>	Collector-emitter voltage	$V_{GE} = 0V$	1200	V
V <sub>GES</sub>	Gate-emitter voltage	-	±20	V
I <sub>C25</sub>	Continuous collector current	T <sub>case</sub> = 25°C	40	Α
I <sub>C85</sub>	Continuous collector current	$T_{case} = 85^{\circ}C$	25	Α
I <sub>CM</sub>	Pulsed collector current	1ms, T <sub>case</sub> = 85°C	75	Α
P <sub>tot</sub>	Power dissipation	$T_{case} = 85^{\circ}C$	100	w

## THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Conditions	Min.	Max.	Units
R <sub>th(j-c)</sub>	Thermal resistance - IGBT	DC junction to case	-	0.65	°C/W
R <sub>th(j-c)</sub>	Thermal resistance - Diode	DC junction to case	-	1.0	°C/W
T <sub>OP</sub>	Operating junction temperature range	-	-40	150	°C
T <sub>stg</sub>	Storage temperature range	-	-40	150	.c
-	Mounting torque	M3 screw	-	1.1	Nm

## DC ELECTRICAL CHARACTERISTICS

T<sub>case</sub> = 25°C unless stated otherwise.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
I <sub>CES</sub>	Collector cut-off current	V <sub>GE</sub> = 0V, V <sub>CE</sub> = 1200V	-	-	1	mA
I <sub>GES</sub>	Gate leakage current	$V_{GE} = 20V, V_{CE} = 0V$	-	-	±500	nA
$V_{\text{GE(TH)}}$	Gate threshold voltage	$I_{\rm C}$ = 1mA, $V_{\rm CE}$ = $V_{\rm GE}$	4.5	6	7.5	٧
V <sub>CE(SAT)</sub>	Collector-emitter saturation voltage	V <sub>GE</sub> = 15V, I <sub>C</sub> = 25A	-	2.8	3.3	٧
		V <sub>GE</sub> = 15V, I <sub>C</sub> = 25A, T <sub>j</sub> = 125°C	-	3.4	-	٧

### **AC ELECTRICAL CHARACTERISTICS**

 $T_{case} = 25$ °C unless stated otherwise.

Symbol		Conditions	Min.	Тур.	Max.	Units
C <sub>ies</sub>	Input capacitance	V <sub>CE</sub> = 25V, V <sub>GE</sub> = 15V, f = 1MHz	-	4385	-	рF
C <sub>oes</sub>	Output capacitance	V <sub>CE</sub> = 25V, V <sub>GE</sub> = 15V, f = 1MHz	-	325	-	рF
C <sub>res</sub>	Reverse transfer capacitance	V <sub>CE</sub> = 25V, V <sub>GE</sub> = 15V, f = 1MHz	-	65	-	рF

## INDUCTIVE SWITCHING CHARACTERISTICS - see figures 3 to 5

 $T_{case}$  = 25°C unless stated otherwise.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
t <sub>d(ON)</sub>	Turn-on delay time		-	90	-	ns
t <sub>r</sub>	Rise time	J 25A	-	35	-	ns
E <sub>on</sub>	Turn-on energy loss - per cycle	$I_{C} = 25A,$ $V_{GE} = \pm 15V,$	-	2.2	-	mJ
t <sub>d(OFF)</sub>	Turn-off delay time	$V_{CE} = 50\%V_{ces}$	-	190	-	ns
t,	Fall time	$R_{G(ON)} = 20\Omega$ $R_{G(OFF)} = 5\Omega$	-	60	-	ns
E <sub>OFF</sub>	Turn-off energy loss - per cycle		-	2.5	-	mJ
T <sub>case</sub> = 125	C unless stated otherwise.		•			
$t_{d(ON)}$	Turn-on delay time		-	90	-	ns
t <sub>r</sub>	Rise time	J 25A	-	40	-	ns
E <sub>on</sub>	Turn-on energy loss - per cycle	$I_{C} = 25A,$ $V_{GE} = \pm 15V,$ $V_{CE} = 50\%V_{ces}$ $R_{G(ON)} = 20\Omega$ $R_{G(OFF)} = 5\Omega$	-	3.5	-	mJ
t <sub>d(OFF)</sub>	Turn-off delay time		-	210	-	ns
t,	Fall time		-	80	-	ns
E <sub>OFF</sub>	Turn-off energy loss - per cycle		-	3.1	-	mJ

For additional switching information please refer to figures 8 to 13.

## **SHORT CIRCUIT RATING**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
t <sub>sc</sub>	Short circuit withstand time	$T_c = 125^{\circ}C, V_{GE} = 15V, V_{CE} = 80\% V_{CES}$	-	-	10	μs

## **ITZ25C12**

### **DIODE CHARACTERISTICS**

T<sub>c</sub> = 25°C unless stated otherwise.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V <sub>FM</sub>	Forward voltage	At I <sub>F</sub> = 25A peak	-	1.9	-	٧
		At I <sub>F</sub> = 25A peak, T <sub>case</sub> = 125°C	-	1.92	-	٧
t <sub>rr</sub>	Reverse recovery time	I <sub>F</sub> = 25A, di <sub>RR</sub> /dt = 200A/μs	-	90	-	ns
I <sub>RRM</sub>	Reverse recovery current	$V_R = 50\%V_{RRM}$	-	12	-	Α

## **BASIC TEST CIRCUIT AND SWITCHING DEFINITIONS**

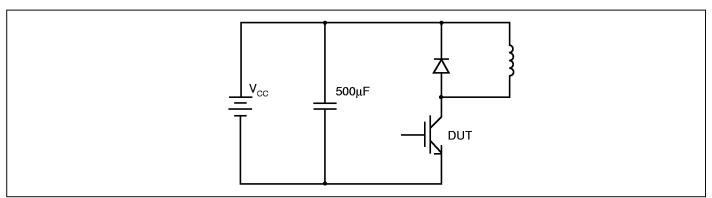


Fig.3 Basic d.c. chopper circuit

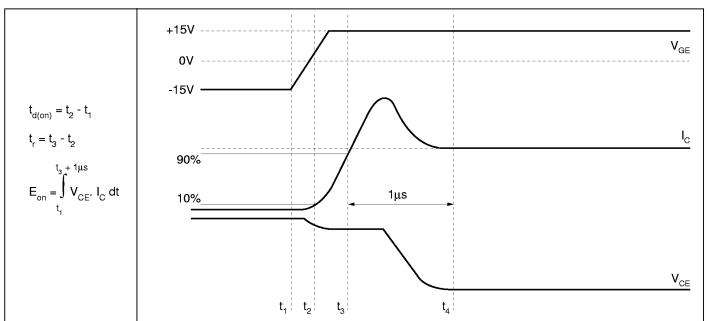


Fig.4 Turn-on characteristics

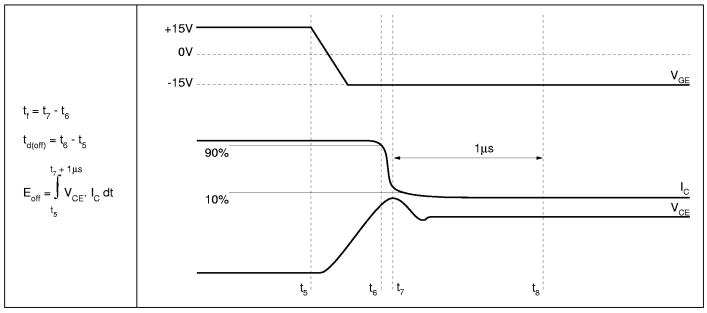
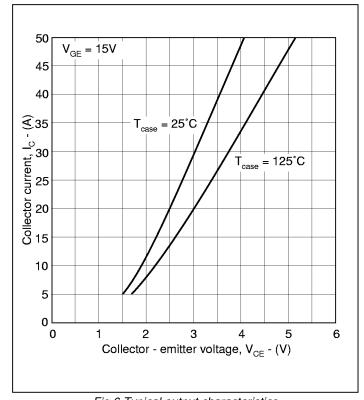
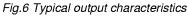


Fig.5 Turn-off characteristics

### **CURVES**





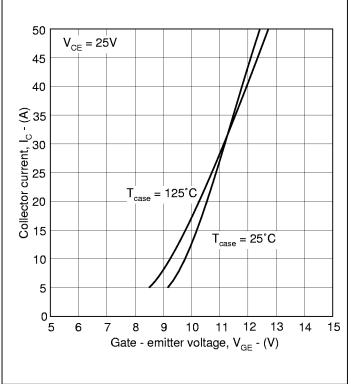
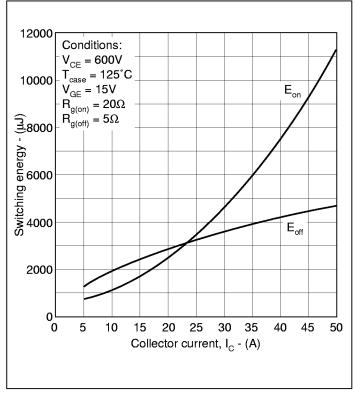


Fig.7 Typical transfer characteristics



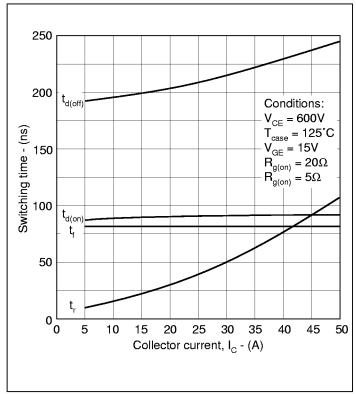
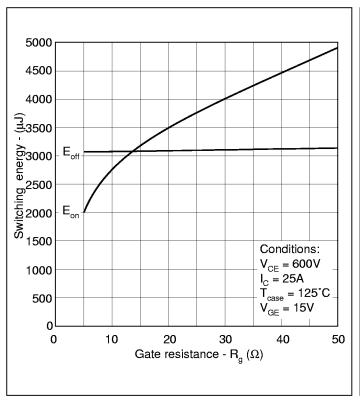
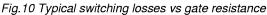


Fig.8 Typical switching losses vs collector current

Fig.9 Typical switching times vs collector current





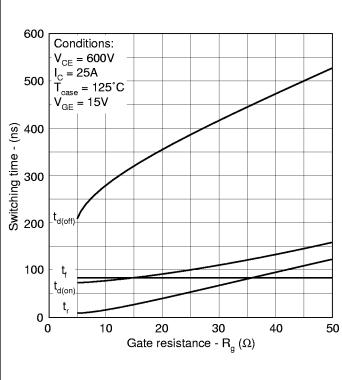
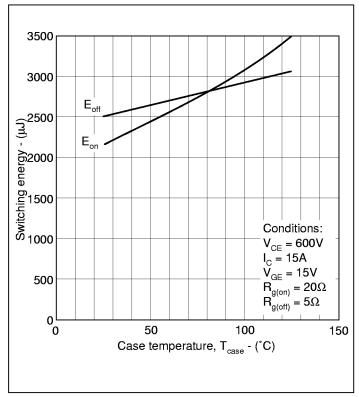


Fig.11 Typical switching times vs gate resistance



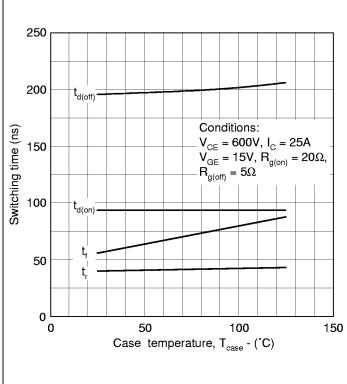
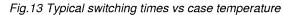
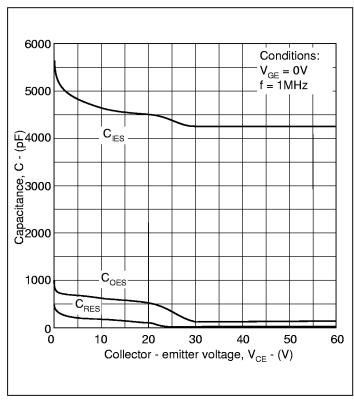
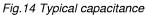


Fig.12 Typical switching losses vs case temperature







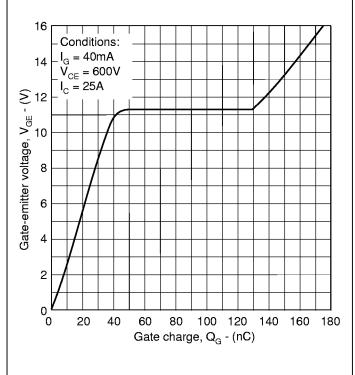
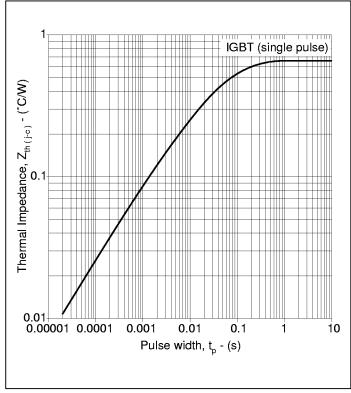


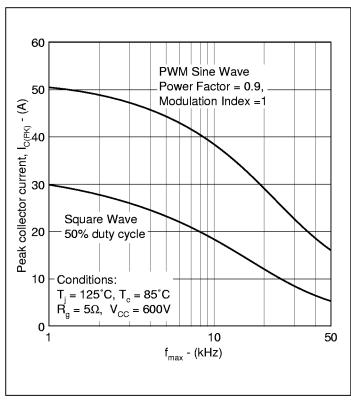
Fig.15 Typical gate charge

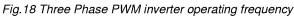


I<sub>C</sub> - (A) Collector current, Conditions:  $\begin{array}{l} -\mathsf{T}_{\mathsf{case}} = \mathsf{125}^{\circ}\mathsf{C} \\ \mathsf{V}_{\mathsf{GE}} = \pm \mathsf{15V} \\ -\mathsf{R}_{\mathsf{g}} = \mathsf{25}\Omega \end{array}$ Collector - emitter voltage,  $V_{\text{CE}}$  - (V)

Fig.16 Transient thermal impedance - junction to case

Fig.17 Reverse bias safe operating area





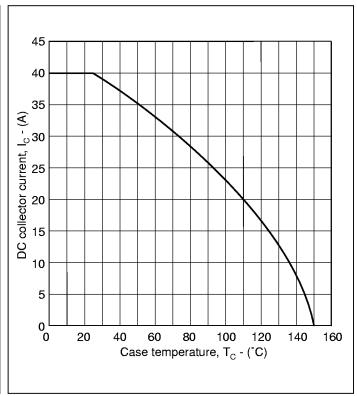


Fig.19 DC current rating vs case temperature

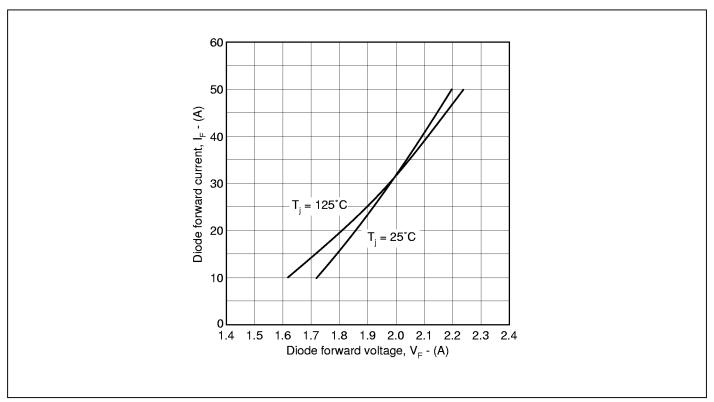
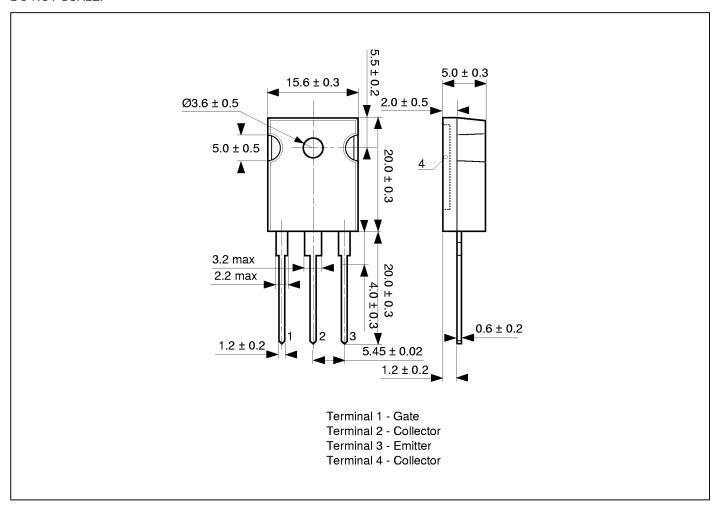


Fig.20 Diode typical forward characteristics

#### **ITZ25C12**

#### **PACKAGE OUTLINE - TO247**

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





HEADQUARTERS POWER OPERATIONS

MITEL SEMICONDUCTOR

Doddington Road, Lincoln, LN6 3LF, United Kingdom. Tel: + 44 (0)1522 500500 Fax: + 44 (0)1522 500550 Internet: http://www.mitelsemi.com

e-mail: power\_solutions@mitel.com

POWER PRODUCT CUSTOMER SERVICE CENTRES

- FRANCE, BENELUX & SPAIN Tel: + 33 (0)1 69 18 90 00 Fax: +33 (0)1 64 46 54 50
- NORTH AMERICA Tel: 011-800-5554-5554 Fax: 011-800-5444-5444
- UK, GERMANY, REST OF WORLD Tel: + 44 (0)1522 500500 Fax : + 44 (0)1522 500020

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